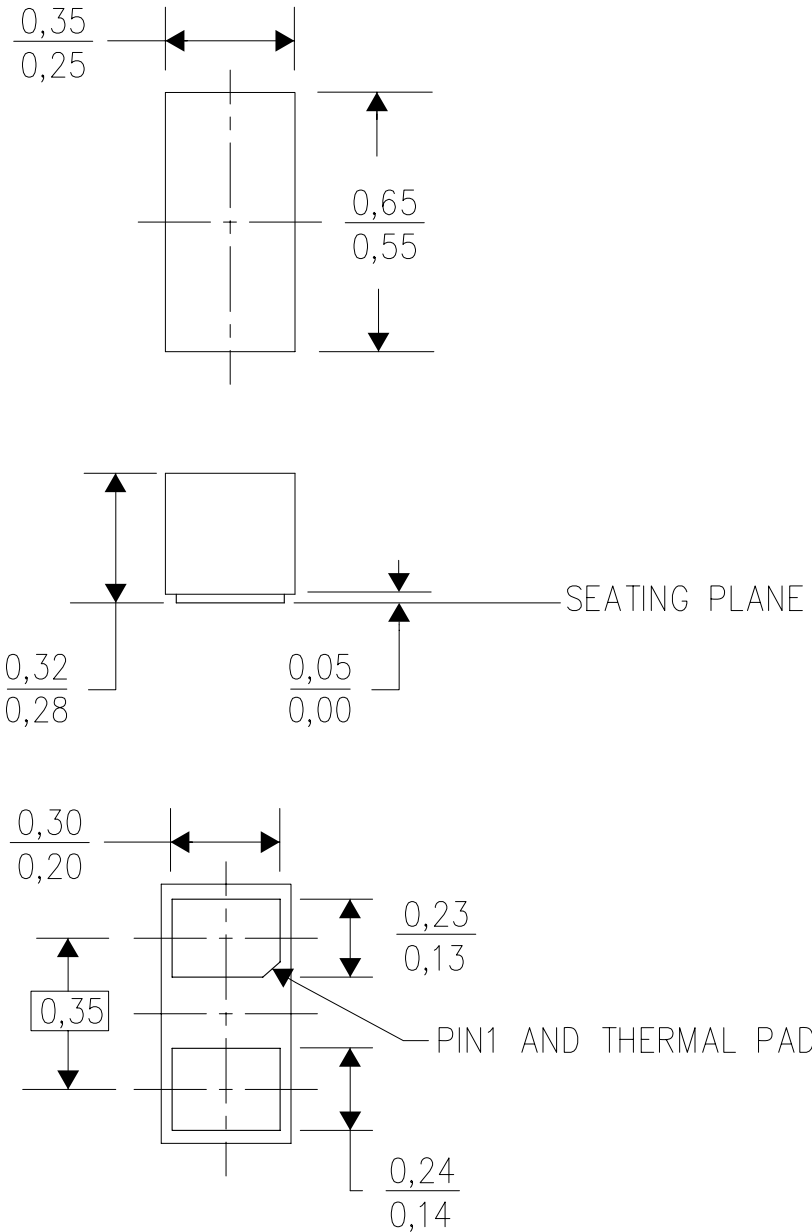


MECHANICAL DATA

DPL (R-PX2SON-N2)

PLASTIC SMALL OUTLINE NO-LEAD



4212149/B 10/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Small Outline No-Lead (SON) package configuration.
 - D. The package thermal pad must be soldered to the board for thermal and mechanical performance.

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